

November 8, 2020

Dear Customer,

This document contains information regarding the status of compliance with Directive 2011/65/EU and its subsequent amendments, including the Directive EU 2015/863 (RoHS-3) for the referenced Si-Ware Systems product(s) below.

Directive EU/2015/863 restricts the use of the following substances in electrical and electronics equipment:

Substance	Threshold Level
Lead	0.1%
Mercury	0.1%
Cadmium	0.01%
Hexavalent Chromium	0.1%
Polybrominated Biphenyls (PBB)	0.1%
Polybrominated Biphenyl ethers (PBDE)	0.1%
Bis(2-Ethylhexyl) Phthalate (DEHP)	0.1%
Benzyl Butyl Phthalate (BBP)	0.1%
Dibutyl phthalate (DBP)	0.1%
Diisobutyl phthalate (DIBP)	0.1%

## Product list

P/N	Products
SWS62231-16	Neospectra Micro

Si-Ware Systems declares that to best of its knowledge the Products listed above **do not** contain any of the these substances: Lead, Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Biphenyl ethers (PBDE), Bis(2-Ethylhexyl) Phthalate (DEHP), Benzyl Butyl Phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP) above 0.1% and of Cadmium above 0.01%. We also claim that some exemptions are applicable on some components shown below per Directive 2011/65/EU – Annex III

MFG	MFG PN		Exemption
Samsung Electro- Mechanics	RC1608F1052CS	7(c)-l	Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors
	RC0603F1022CS		
	RC1608F4992CS		
	RC1608F3162CS		
	RC1608F204CS		
	RC0603F203CS		
	RC0603J000CS		
	RC1005F4990CS		
Bourns Inc.	CR0603-FX-4992ELF	7(c)-I	Electrical and electronic
	CR0603-FX-3162ELF		components containing lead in a
	CR0603-FX-2003ELF		glass or ceramic other than
	CR0402-FX-2263GLF		dielectric ceramic in capacitors

Exemptions list permitted by Directive 2011/65/EU – Annex III

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## **RoHS Statement**

	CR0201-J/-000GLF		
	CR0402-FX-4990GLF		
	RMCF0201FT2K15		
	RMCF0201FT10K0		
	RMCF0603FT10K5		Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors
	RMCF0201FT10K2	7(c)-l	
	RMCF0603FT49K9		
	RMCF0603FT31K6		
	RMCF0201FT1M00		
	RMCF0201FT14K0		
Stackpole Electronics Inc.	RMCS0201FT14K0		
	RMCF0603FT200K		
	RMCF0201FT499K		
	RMCF0201FT100K		
	RMCF0402FT2M15		
	RMCF0402FT226K		
	RMCF0201FT40K2		
	RMCF0201FT20K0		
	RMCF0402FT499R		
	RMCF0201FT604R		
			Electrical and electronic
TE Connectivity		7(a)	components containing lead in a
Passive Product	CRG0201F100K	7(c)-l	glass or ceramic other than
			dielectric ceramic in capacitors
		7(c)-l	Electrical and electronic
Vishay Beyschlag	MCS04020Z0000ZE00		components containing lead in a
visitay Deyschlag	0		glass or ceramic other than
			dielectric ceramic in capacitors
	9774015243R		Lead as an alloying element in
			steel for machining purposes
Wurth Electronics		a( ) .	containing up to 0,35 % lead by
Inc.	9774050243R	6(a)-I	weight and in batch hot dip
-			galvanised steel components
			containing up to 0,2 % lead by
			weight.
	RC0201JR-072ML		
	RC0201FR-072K15L		
	AC0201FR-072K15L		
	RC0201FR-0710KL		
	AC0201FR-0710KL		
	RC0201FR-0710KP		
	RC0603FR-0710K5L		Electrical and electronic
	RC0201FR-0710K2L		components containing lead in a
Yageo	AC0201FR-0710K2L	7(c)-l	glass or ceramic other than
	RC0603FR-0749K9L		dielectric ceramic in capacitors
	RC0603FR-0731K6L		
	RC0201FR-071ML		
	AC0201FR-071ML		
	RC0201FR-0714KL		
	RC0603FR-07200KL		
	AC0603FR-07200KL		
	RC0201FR-07499KL		

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2 of 3

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## **RoHS Statement**

AC0201FR-07499KL RC0201FR-07100KL RC0402FR-07226KL AC0402FR-07226KL AC0201FR-0740K2L RC0201FR-0740K2L RC0201FR-0720KL		
RC0402FR-07226KL AC0402FR-07226KL AC0201FR-0740K2L RC0201FR-0740K2L		
AC0402FR-07226KL AC0201FR-0740K2L RC0201FR-0740K2L		
AC0201FR-0740K2L RC0201FR-0740K2L		
RC0201FR-0740K2L		
RC0201ER-0720KI		
AC0201FR-0720KL		
AC0201FR-0739RL		
RC0201FR-0739RL		
RC0201JR-070RL		
RC0201FR-07100KL		
RC0402FR-07499RL		
AC0402FR-07499RL		
RC0201FR-07604RL		
AC0201FR-07604RL		
RC0201JR-070RL		
BZ-ZC008-2	6(a)	Lead as an alloying element in steel for machining purposes containing up to 0,35 % lead by weight and in batch hot dip galvanised steel components
BZ-ZC008-1	6(c)	containing up to 0,2 % lead by weight. Copper alloy containing up to 4% lead by weight
	AC0201FR-0739RL RC0201FR-0739RL RC0201JR-070RL RC0201FR-07100KL RC0402FR-07499RL AC0402FR-07499RL RC0201FR-07604RL AC0201FR-07604RL RC0201JR-070RL BZ-ZC008-2	AC0201FR-0739RL   RC0201FR-0739RL   RC0201JR-070RL   RC0201FR-07100KL   RC0402FR-07499RL   AC0402FR-07499RL   AC0402FR-07604RL   AC0201FR-07604RL   RC0201JR-070RL   BZ-ZC008-2   BZ-ZC008-1

This declaration is based solely on RoHS certifications provided by our component suppliers and contract manufacturers without having conducted any independent research, testing or evaluation. In the event one of the above mentioned products are altered or somehow reconfigured by someone other than Si-Ware Systems, this declaration is rendered invalid.

Mohamed Elarabay

Mohamed Elarabawy Production Director

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